

## IGBT

High speed IGBT in Trench and Fieldstop technology

## IGW15N120H3

1200V high speed switching series third generation

Data sheet

High speed IGBT in Trench and Fieldstop technology

**Features:**

TRENCHSTOP™ technology offering

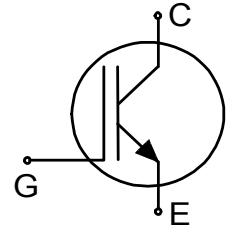
- very low turn-off energy
- low  $V_{CEsat}$
- low EMI
- maximum junction temperature 175°C
- qualified according to JEDEC for target applications
- Pb-free lead plating, halogen-free mould compound, RoHS compliant
- complete product spectrum and PSpice Models:  
<http://www.infineon.com/igbt/>

**Applications:**

- uninterruptible power supplies
- welding converters
- converters with high switching frequency

**Package pin definition:**

- Pin 1 - gate
- Pin 2 & backside - collector
- Pin 3 - emitter



**Key Performance and Package Parameters**

| Type        | $V_{CE}$ | $I_C$ | $V_{CEsat}, T_{vj}=25^{\circ}C$ | $T_{vjmax}$ | Marking  | Package    |
|-------------|----------|-------|---------------------------------|-------------|----------|------------|
| IGW15N120H3 | 1200V    | 15A   | 2.05V                           | 175°C       | G15H1203 | PG-TO247-3 |



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**Maximum Ratings**

For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

| Parameter   | Symbol      | Value          | Unit             |
|---|-------------|----------------|------------------|
| Collector-emitter voltage   | $V_{CE}$    | 1200           | V                |
| DC collector current, limited by $T_{vjmax}$<br>$T_C = 25^\circ\text{C}$<br>$T_C = 100^\circ\text{C}$   | $I_C$       | 30.0<br>15.0   | A                |
| Pulsed collector current, $t_p$ limited by $T_{vjmax}$  | $I_{Cpuls}$ | 60.0           | A                |
| Turn off safe operating area $V_{CE} \leq 1200\text{V}$ , $T_{vj} \leq 175^\circ\text{C}$   | -           | 60.0           | A                |
| Gate-emitter voltage  | $V_{GE}$    | $\pm 20$       | V                |
| Short circuit withstand time<br>$V_{GE} = 15.0\text{V}$ , $V_{CC} \leq 600\text{V}$<br>Allowed number of short circuits < 1000<br>Time between short circuits: $\geq 1.0\text{s}$<br>$T_{vj} = 175^\circ\text{C}$ | $t_{SC}$    | 10             | $\mu\text{s}$    |
| Power dissipation $T_C = 25^\circ\text{C}$<br>Power dissipation $T_C = 100^\circ\text{C}$   | $P_{tot}$   | 217.0<br>105.0 | W                |
| Operating junction temperature  | $T_{vj}$    | -40...+175     | $^\circ\text{C}$ |
| Storage temperature   | $T_{stg}$   | -55...+150     | $^\circ\text{C}$ |
| Soldering temperature,<br>wave soldering 1.6mm (0.063in.) from case for 10s   |             | 260            | $^\circ\text{C}$ |
| Mounting torque, M3 screw<br>Maximum of mounting processes: 3   | $M$         | 0.6            | Nm               |

**Thermal Resistance**

| Parameter                                   | Symbol        | Conditions | Max. Value | Unit |
|---|---------------|------------|------------|------|
| <b>Characteristic</b>                       |               |            |            |      |
| IGBT thermal resistance,<br>junction - case | $R_{th(j-c)}$ |            | 0.70       | K/W  |
| Thermal resistance<br>junction - ambient    | $R_{th(j-a)}$ |            | 40         | K/W  |

**Electrical Characteristic, at  $T_{vj} = 25^\circ\text{C}$ , unless otherwise specified**

| Parameter                            | Symbol        | Conditions  | Value       |                      |                 | Unit          |
|--------------------------------------|---------------|---|-------------|----------------------|-----------------|---------------|
|                                      |               |   | min.        | typ.                 | max.            |               |
| <b>Static Characteristic</b>         |               |   |             |                      |                 |               |
| Collector-emitter breakdown voltage  | $V_{(BR)CES}$ | $V_{GE} = 0\text{V}$ , $I_C = 0.50\text{mA}$  | 1200        | -                    | -               | V             |
| Collector-emitter saturation voltage | $V_{CEsat}$   | $V_{GE} = 15.0\text{V}$ , $I_C = 15.0\text{A}$<br>$T_{vj} = 25^\circ\text{C}$<br>$T_{vj} = 125^\circ\text{C}$<br>$T_{vj} = 175^\circ\text{C}$ | -<br>-<br>- | 2.05<br>2.50<br>2.70 | 2.40<br>-<br>-  | V             |
| Gate-emitter threshold voltage       | $V_{GE(th)}$  | $I_C = 0.50\text{mA}$ , $V_{CE} = V_{GE}$   | 5.0         | 5.8                  | 6.5             | V             |
| Zero gate voltage collector current  | $I_{CES}$     | $V_{CE} = 1200\text{V}$ , $V_{GE} = 0\text{V}$<br>$T_{vj} = 25^\circ\text{C}$<br>$T_{vj} = 175^\circ\text{C}$                                 | -<br>-      | -<br>-               | 250.0<br>2500.0 | $\mu\text{A}$ |
| Gate-emitter leakage current         | $I_{GES}$     | $V_{CE} = 0\text{V}$ , $V_{GE} = 20\text{V}$  | -           | -                    | 600             | nA            |
| Transconductance                     | $g_{fs}$      | $V_{CE} = 20\text{V}$ , $I_C = 15.0\text{A}$  | -           | 7.5                  | -               | S             |

**Electrical Characteristic, at  $T_{vj} = 25^{\circ}\text{C}$ , unless otherwise specified**

| Parameter  | Symbol      | Conditions  | Value |      |      | Unit |
|--|-------------|---|-------|------|------|------|
|  |             |   | min.  | typ. | max. |      |
| <b>Dynamic Characteristic</b>  |             |   |       |      |      |      |
| Input capacitance  | $C_{ies}$   | $V_{CE} = 25\text{V}, V_{GE} = 0\text{V}, f = 1\text{MHz}$  | -     | 875  | -    | pF   |
| Output capacitance   | $C_{oes}$   |   | -     | 60   | -    |      |
| Reverse transfer capacitance   | $C_{res}$   |   | -     | 45   | -    |      |
| Gate charge  | $Q_G$       | $V_{CC} = 960\text{V}, I_C = 15.0\text{A}, V_{GE} = 15\text{V}$   | -     | 75.0 | -    | nC   |
| Short circuit collector current<br>Max. 1000 short circuits<br>Time between short circuits: $\geq 1.0\text{s}$ | $I_{C(SC)}$ | $V_{GE} = 15.0\text{V}, V_{CC} \leq 600\text{V}, t_{SC} \leq 10\mu\text{s}, T_{vj} = 175^{\circ}\text{C}$ | -     | 52   | -    | A    |

**Switching Characteristic, Inductive Load**

| Parameter | Symbol | Conditions | Value |      |      | Unit |
|-----------|--------|------------|-------|------|------|------|
|           |        |            | min.  | typ. | max. |      |

**IGBT Characteristic, at  $T_{vj} = 25^{\circ}\text{C}$** 

|                        |              |   |   |      |   |    |
|------------------------|--------------|---|---|------|---|----|
| Turn-on delay time     | $t_{d(on)}$  | $T_{vj} = 25^{\circ}\text{C}, V_{CC} = 600\text{V}, I_C = 15.0\text{A}, V_{GE} = 0.0/15.0\text{V}, R_{G(on)} = 35.0\Omega, R_{G(off)} = 35.0\Omega, L\sigma = 95\text{nH}, C\sigma = 67\text{pF}, L\sigma, C\sigma$ from Fig. E<br>Energy losses include "tail" and diode (IKW15N120H3) reverse recovery. | - | 21   | - | ns |
| Rise time              | $t_r$        |   | - | 34   | - | ns |
| Turn-off delay time    | $t_{d(off)}$ |   | - | 260  | - | ns |
| Fall time              | $t_f$        |   | - | 14   | - | ns |
| Turn-on energy         | $E_{on}$     |   | - | 1.10 | - | mJ |
| Turn-off energy        | $E_{off}$    |   | - | 0.45 | - | mJ |
| Total switching energy | $E_{ts}$     |   | - | 1.55 | - | mJ |

**Switching Characteristic, Inductive Load**

| Parameter | Symbol | Conditions | Value |      |      | Unit |
|-----------|--------|------------|-------|------|------|------|
|           |        |            | min.  | typ. | max. |      |

**IGBT Characteristic, at  $T_{vj} = 175^{\circ}\text{C}$** 

|                        |              |  |   |      |   |    |
|------------------------|--------------|--|---|------|---|----|
| Turn-on delay time     | $t_{d(on)}$  | $T_{vj} = 175^{\circ}\text{C}, V_{CC} = 600\text{V}, I_C = 15.0\text{A}, V_{GE} = 0.0/15.0\text{V}, R_{G(on)} = 35.0\Omega, R_{G(off)} = 35.0\Omega, L\sigma = 95\text{nH}, C\sigma = 67\text{pF}, L\sigma, C\sigma$ from Fig. E<br>Energy losses include "tail" and diode (IKW15N120H3) reverse recovery. | - | 19   | - | ns |
| Rise time              | $t_r$        |  | - | 30   | - | ns |
| Turn-off delay time    | $t_{d(off)}$ |  | - | 327  | - | ns |
| Fall time              | $t_f$        |  | - | 43   | - | ns |
| Turn-on energy         | $E_{on}$     |  | - | 1.60 | - | mJ |
| Turn-off energy        | $E_{off}$    |  | - | 0.90 | - | mJ |
| Total switching energy | $E_{ts}$     |  | - | 2.50 | - | mJ |

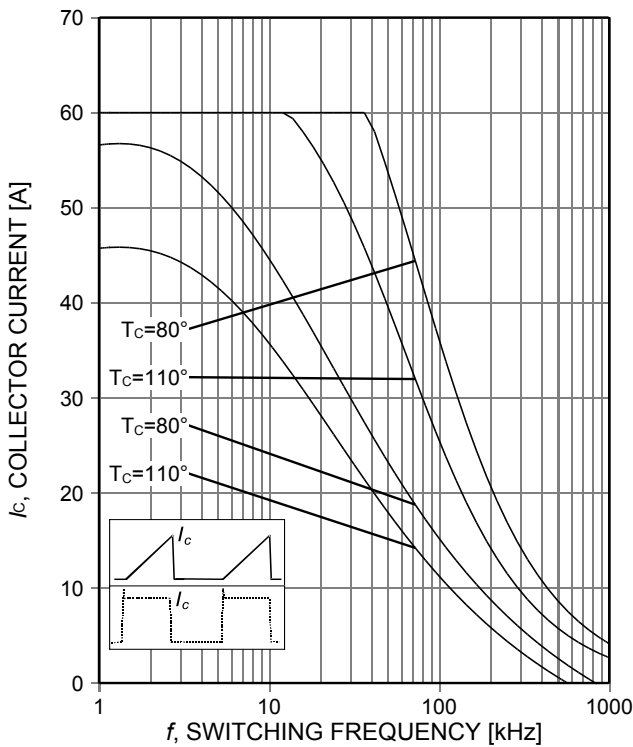


Figure 1. **Collector current as a function of switching frequency**  
 ( $T_j \leq 175^\circ\text{C}$ ,  $D=0.5$ ,  $V_{CE}=600\text{V}$ ,  $V_{GE}=15/0\text{V}$ ,  $r_G=35\Omega$ )

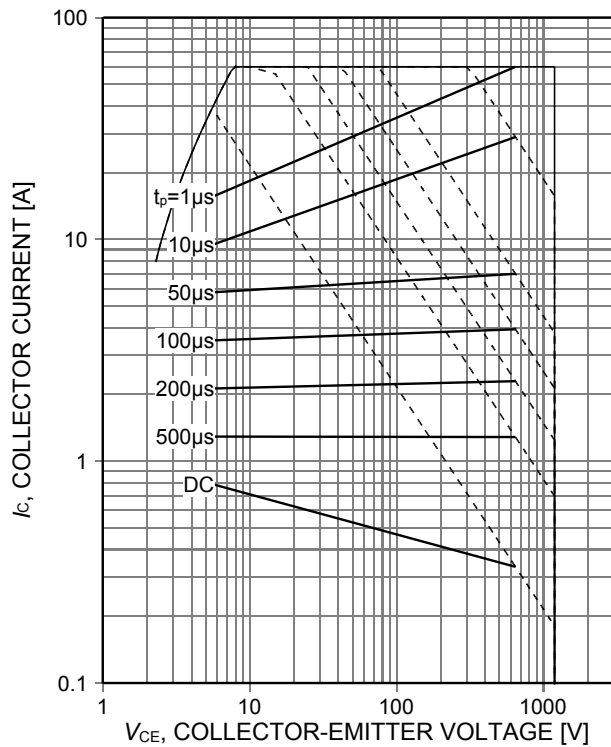


Figure 2. **Forward bias safe operating area**  
 ( $D=0$ ,  $T_C=25^\circ\text{C}$ ,  $T_j \leq 175^\circ\text{C}$ ;  $V_{GE}=15\text{V}$ )

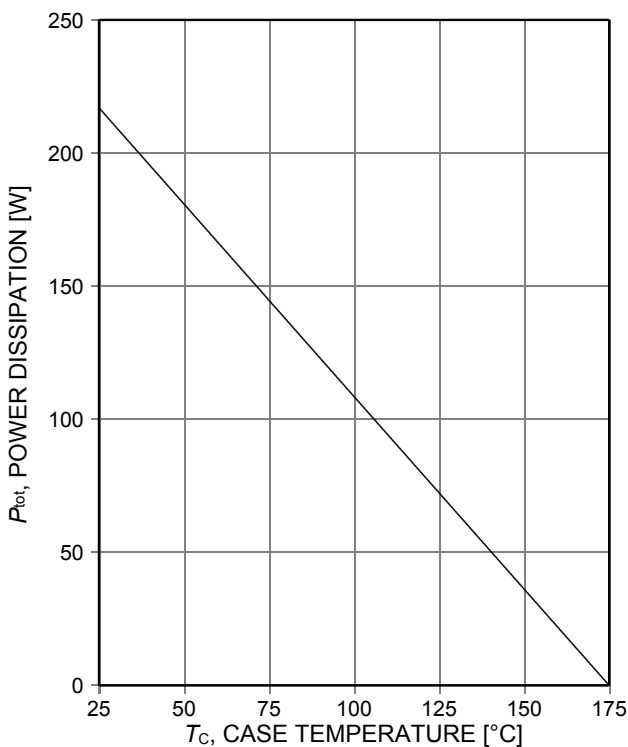


Figure 3. **Power dissipation as a function of case temperature**  
 ( $T_j \leq 175^\circ\text{C}$ )

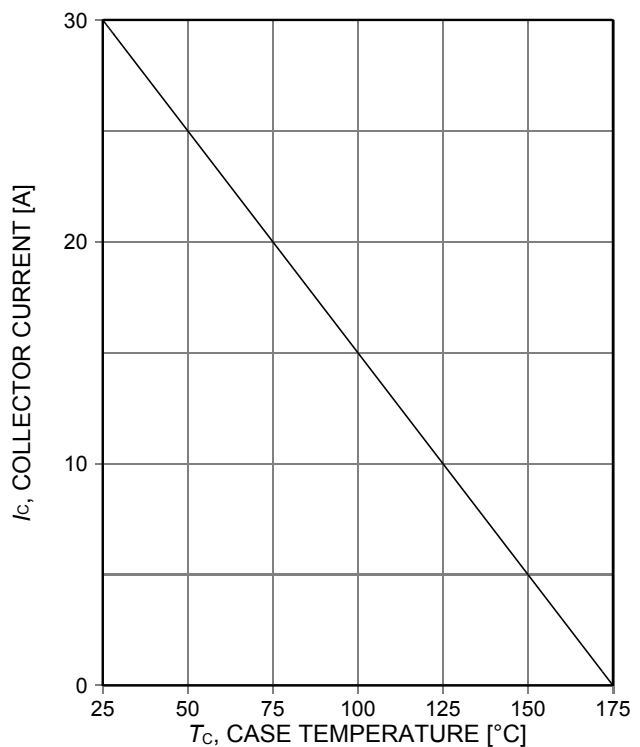


Figure 4. **Collector current as a function of case temperature**  
 ( $V_{GE} \geq 15\text{V}$ ,  $T_j \leq 175^\circ\text{C}$ )

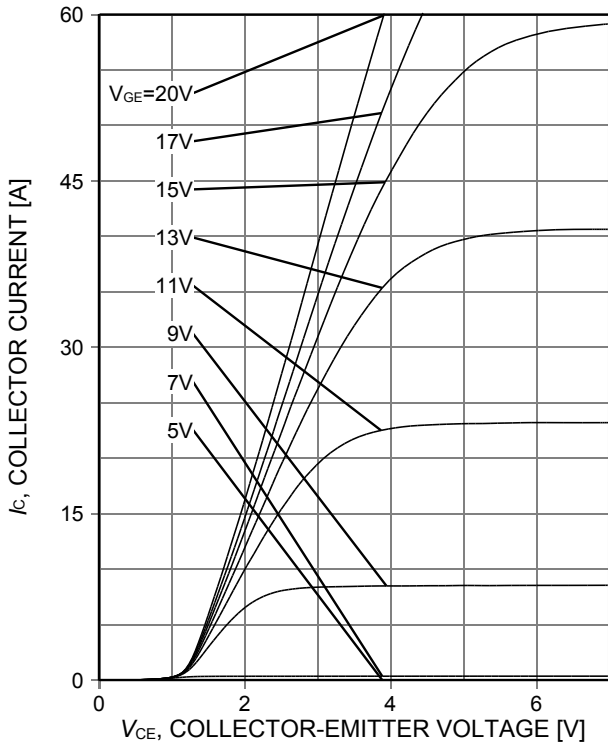


Figure 5. **Typical output characteristic**  
( $T_j=25^\circ\text{C}$ )

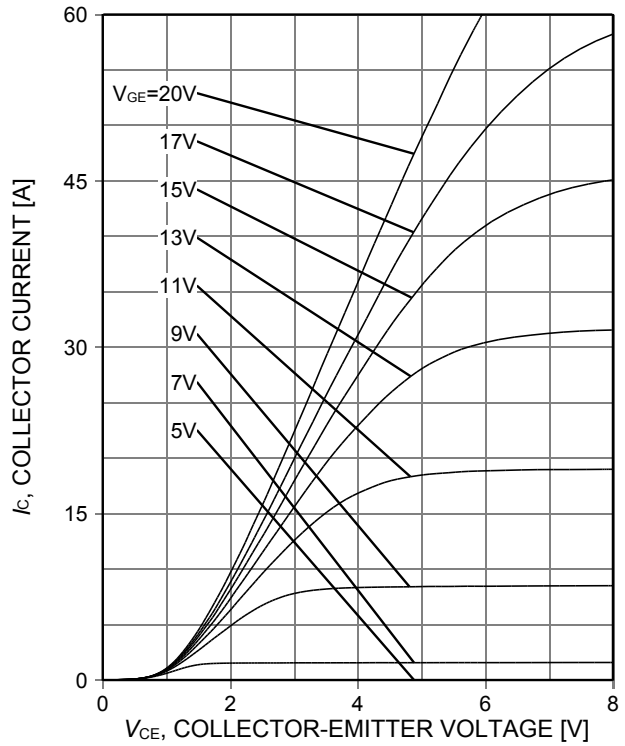


Figure 6. **Typical output characteristic**  
( $T_j=175^\circ\text{C}$ )

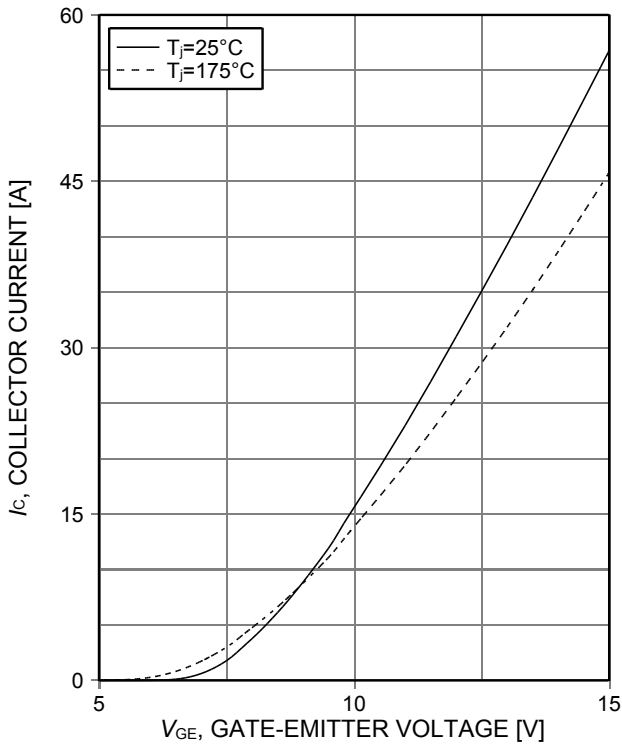


Figure 7. **Typical transfer characteristic**  
( $V_{CE}=20\text{V}$ )

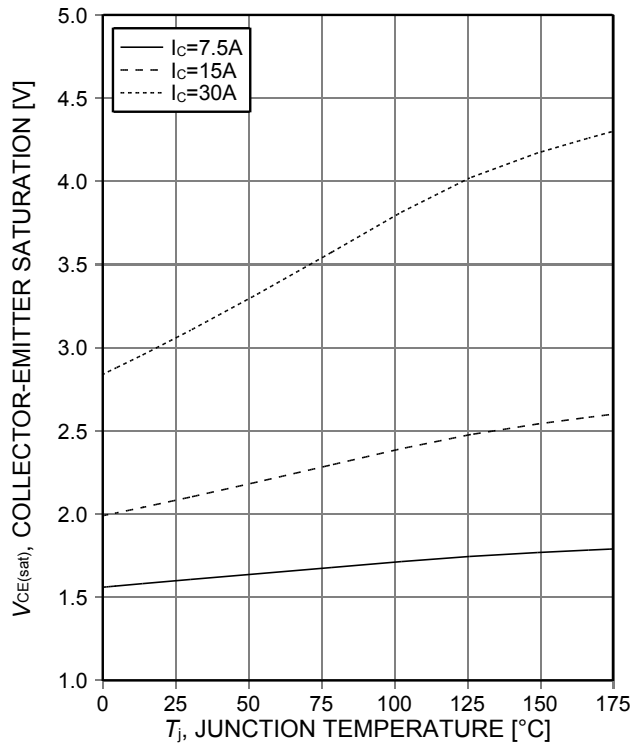


Figure 8. **Typical collector-emitter saturation voltage as a function of junction temperature**  
( $V_{GE}=15\text{V}$ )

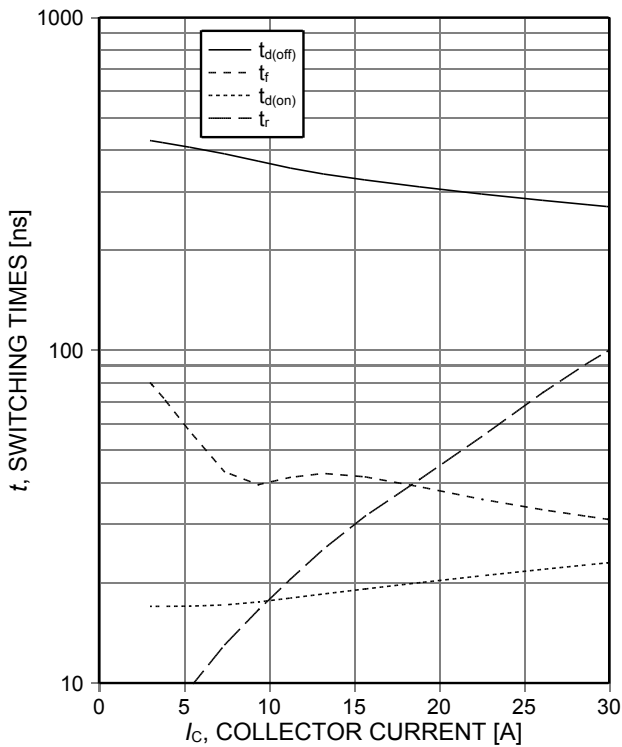


Figure 9. **Typical switching times as a function of collector current**  
(ind. load,  $T_J=175^\circ\text{C}$ ,  $V_{CE}=600\text{V}$ ,  $V_{GE}=15/0\text{V}$ ,  $r_G=35\Omega$ , test circuit in Fig. E)

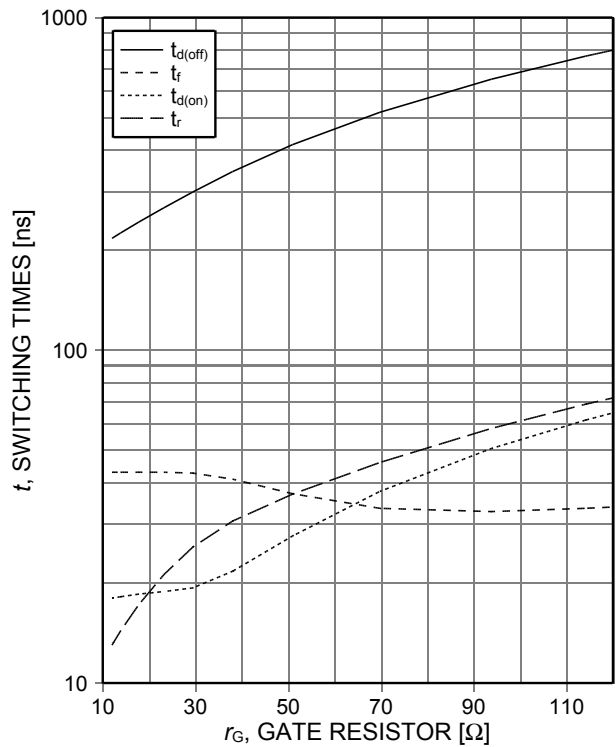


Figure 10. **Typical switching times as a function of gate resistor**  
(ind. load,  $T_J=175^\circ\text{C}$ ,  $V_{CE}=600\text{V}$ ,  $V_{GE}=15/0\text{V}$ ,  $I_C=15\text{A}$ , test circuit in Fig. E)

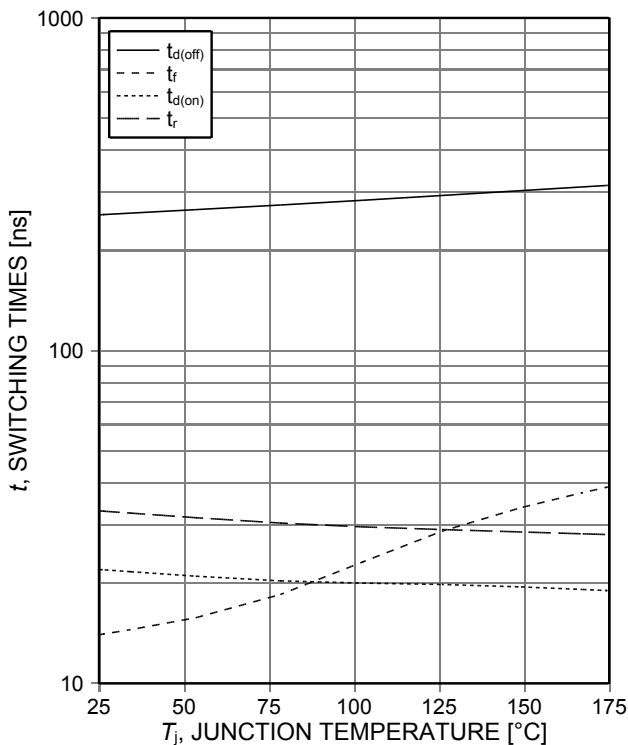


Figure 11. **Typical switching times as a function of junction temperature**  
(ind. load,  $V_{CE}=600\text{V}$ ,  $V_{GE}=15/0\text{V}$ ,  $I_C=15\text{A}$ ,  $r_G=35\Omega$ , test circuit in Fig. E)

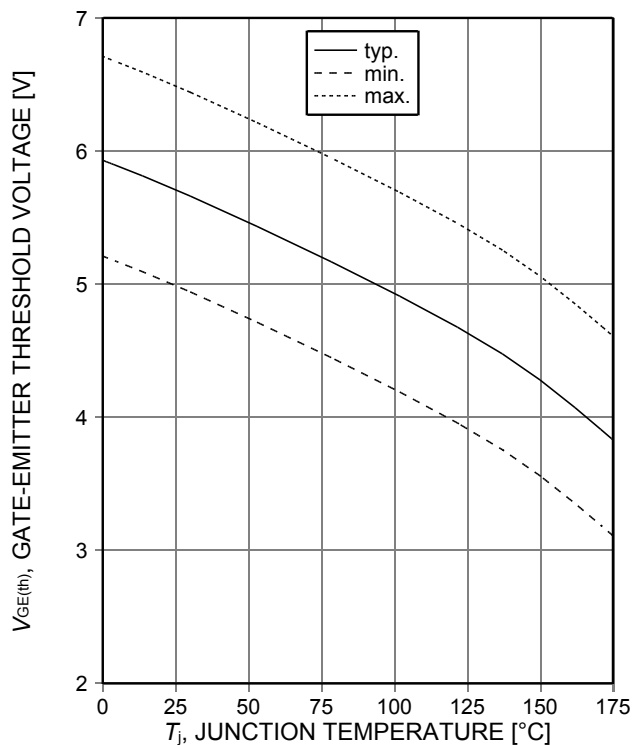


Figure 12. **Gate-emitter threshold voltage as a function of junction temperature**  
( $I_C=0.5\text{mA}$ )



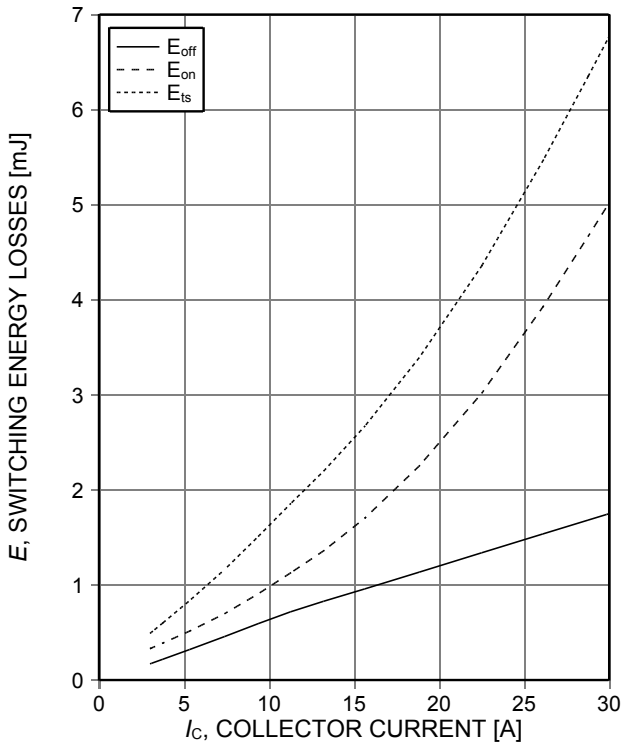


Figure 13. **Typical switching energy losses as a function of collector current**  
 (ind. load,  $T_J=175^\circ\text{C}$ ,  $V_{CE}=600\text{V}$ ,  $V_{GE}=15/0\text{V}$ ,  $r_G=35\Omega$ , test circuit in Fig. E)

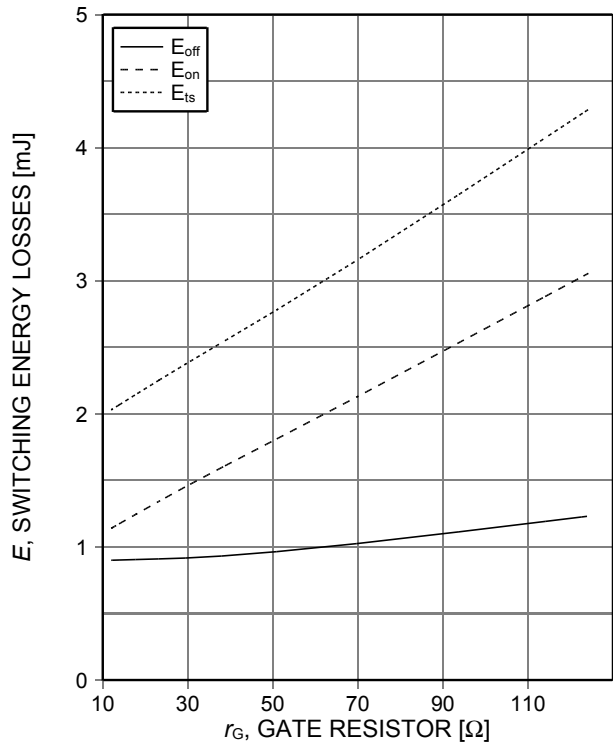


Figure 14. **Typical switching energy losses as a function of gate resistor**  
 (ind. load,  $T_J=175^\circ\text{C}$ ,  $V_{CE}=600\text{V}$ ,  $V_{GE}=15/0\text{V}$ ,  $I_C=15\text{A}$ , test circuit in Fig. E)

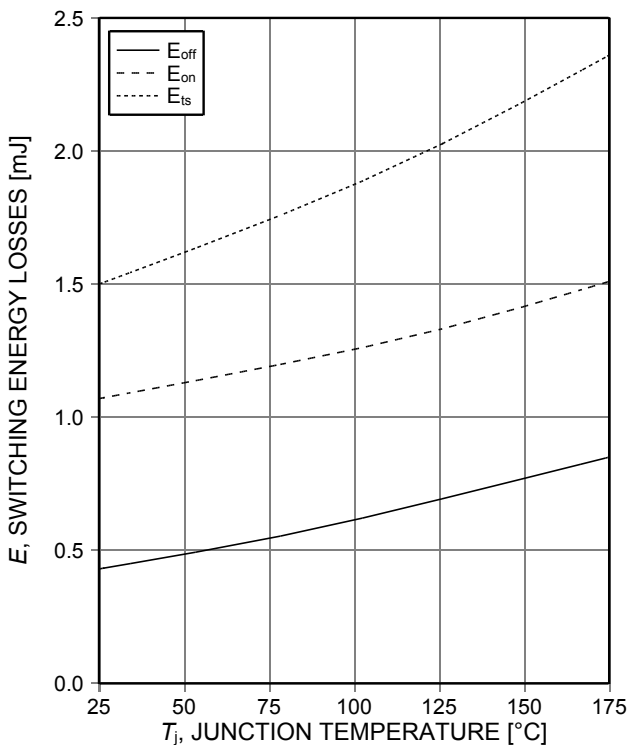


Figure 15. **Typical switching energy losses as a function of junction temperature**  
 (ind load,  $V_{CE}=600\text{V}$ ,  $V_{GE}=15/0\text{V}$ ,  $I_C=15\text{A}$ ,  $r_G=35\Omega$ , test circuit in Fig. E)

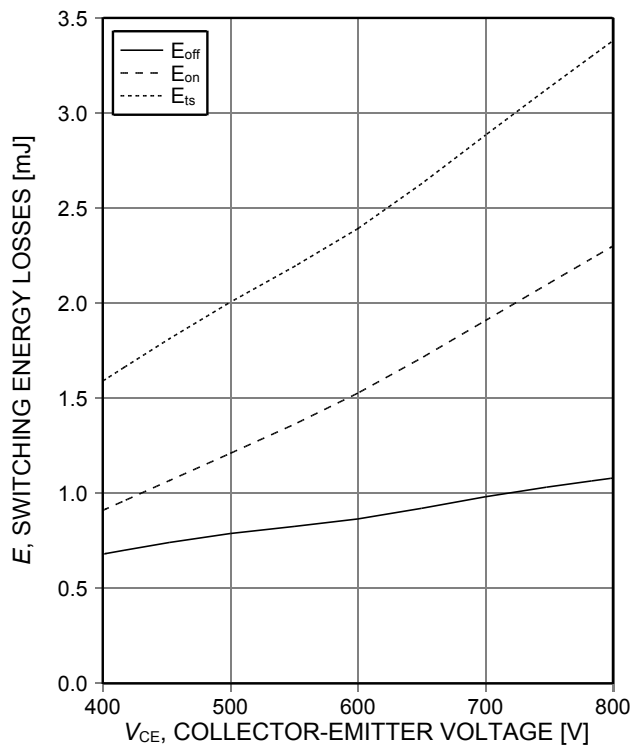


Figure 16. **Typical switching energy losses as a function of collector emitter voltage**  
 (ind. load,  $T_J=175^\circ\text{C}$ ,  $V_{GE}=15/0\text{V}$ ,  $I_C=15\text{A}$ ,  $r_G=35\Omega$ , test circuit in Fig. E)

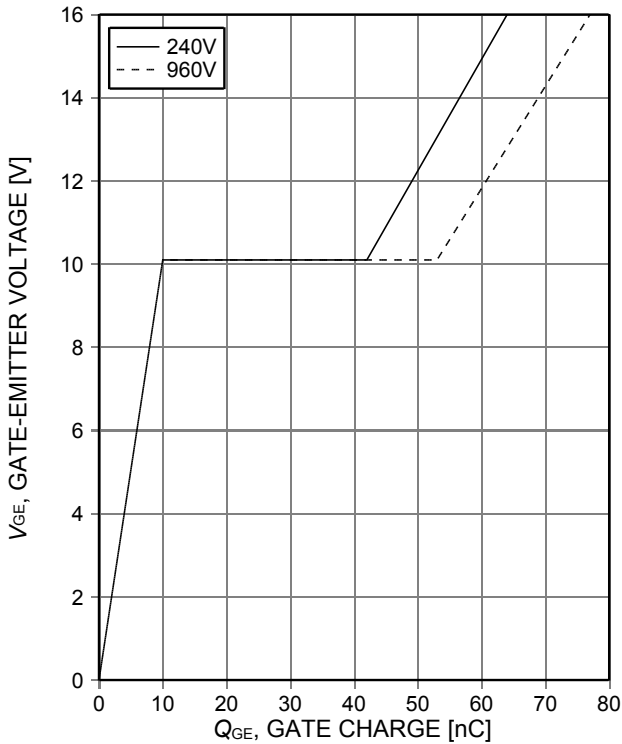


Figure 17. **Typical gate charge**  
( $I_C=15A$ )

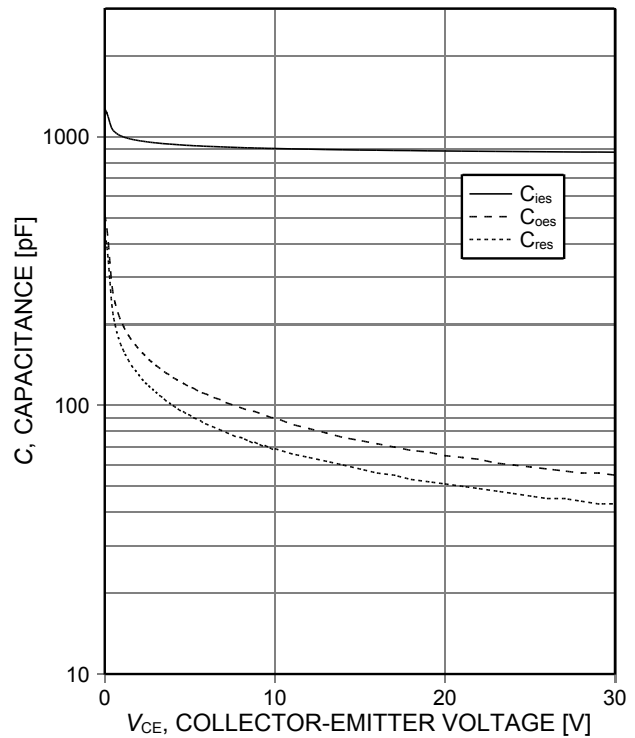


Figure 18. **Typical capacitance as a function of collector-emitter voltage**  
( $V_{GE}=0V$ ,  $f=1MHz$ )

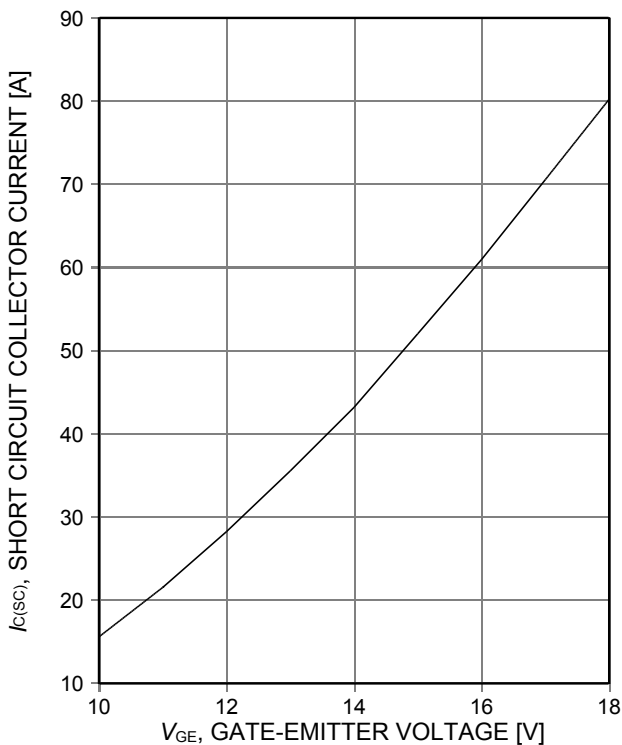


Figure 19. **Typical short circuit collector current as a function of gate-emitter voltage**  
( $V_{CE}\leq 600V$ , start at  $T_j=25^\circ C$ )

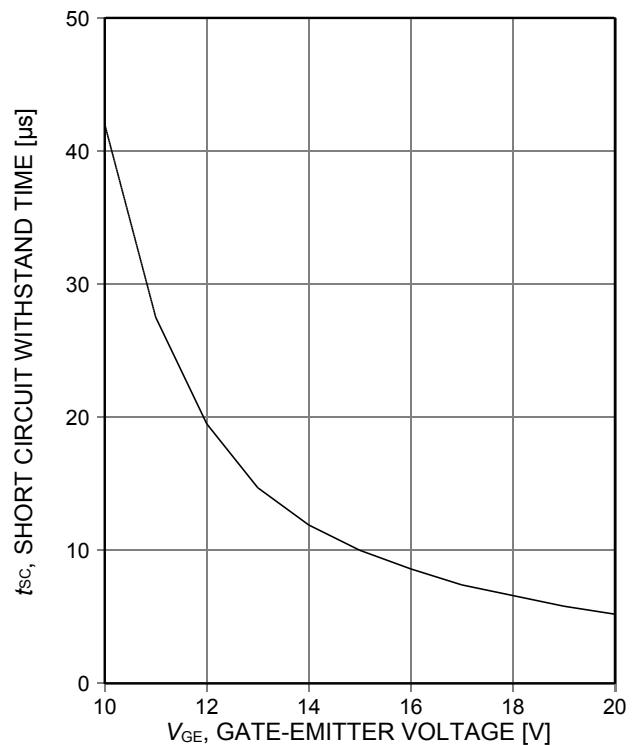


Figure 20. **Short circuit withstand time as a function of gate-emitter voltage**  
( $V_{CE}\leq 600V$ , start at  $T_j\leq 150^\circ C$ )

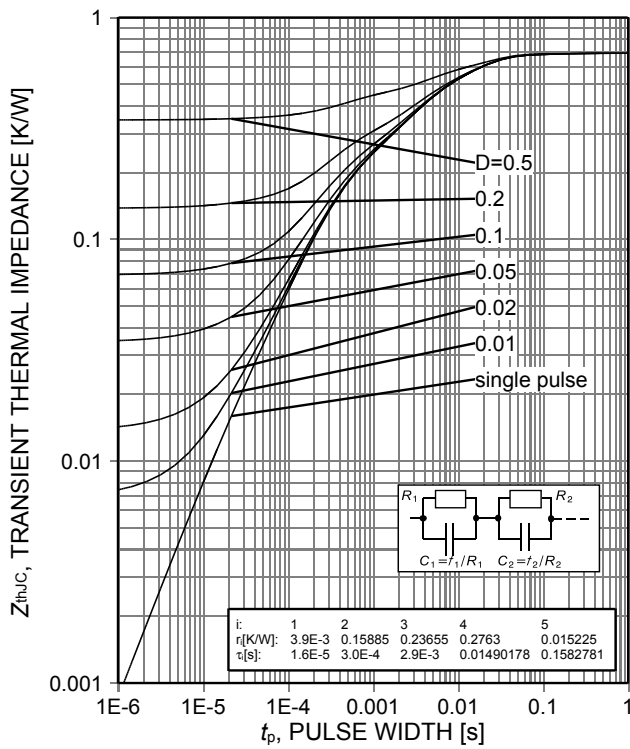
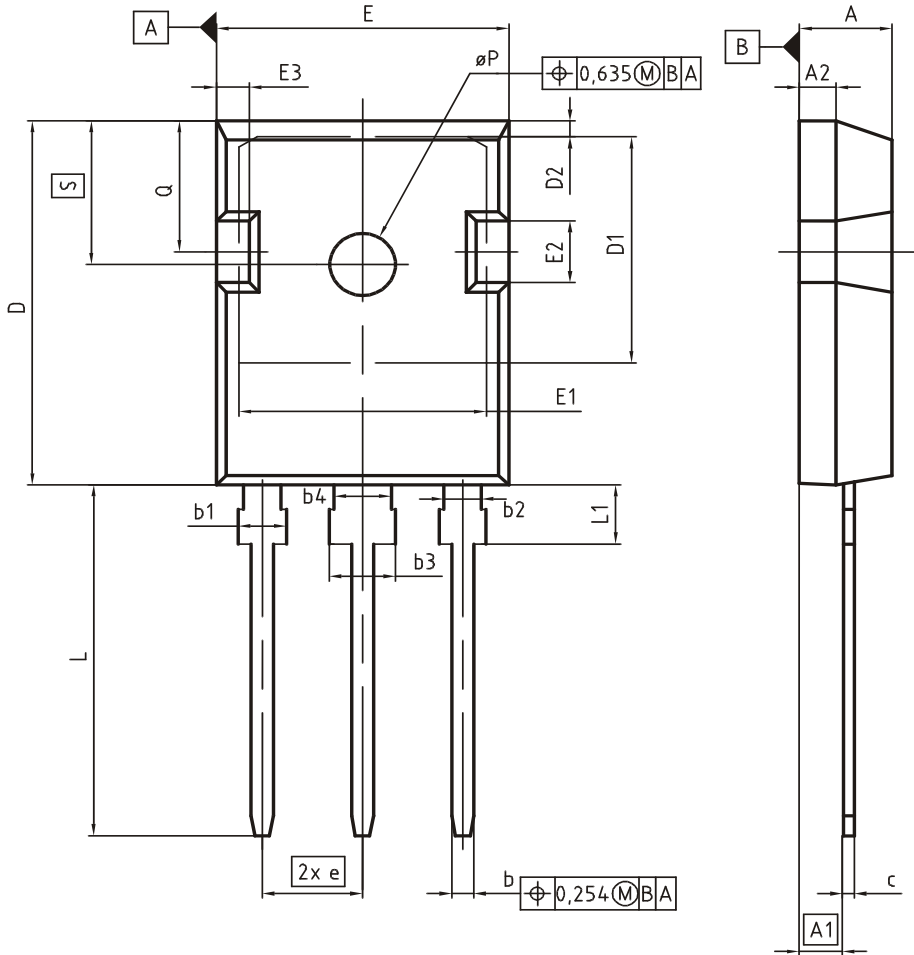


Figure 21. IGBT transient thermal impedance ( $D=t_p/T$ )

PG-TO247-3



| DIM | MILLIMETERS |       | INCHES      |       |
|-----|-------------|-------|-------------|-------|
|     | MIN         | MAX   | MIN         | MAX   |
| A   | 4.83        | 5.21  | 0.190       | 0.205 |
| A1  | 2.27        | 2.54  | 0.089       | 0.100 |
| A2  | 1.85        | 2.16  | 0.073       | 0.085 |
| b   | 1.07        | 1.33  | 0.042       | 0.052 |
| b1  | 1.90        | 2.41  | 0.075       | 0.095 |
| b2  | 1.90        | 2.16  | 0.075       | 0.085 |
| b3  | 2.87        | 3.38  | 0.113       | 0.133 |
| b4  | 2.87        | 3.13  | 0.113       | 0.123 |
| c   | 0.55        | 0.68  | 0.022       | 0.027 |
| D   | 20.80       | 21.10 | 0.819       | 0.831 |
| D1  | 16.25       | 17.65 | 0.640       | 0.695 |
| D2  | 0.95        | 1.35  | 0.037       | 0.053 |
| E   | 15.70       | 16.13 | 0.618       | 0.635 |
| E1  | 13.10       | 14.15 | 0.516       | 0.557 |
| E2  | 3.68        | 5.10  | 0.145       | 0.201 |
| E3  | 1.00        | 2.60  | 0.039       | 0.102 |
| e   | 5.44 (BSC)  |       | 0.214 (BSC) |       |
| N   | 3           |       | 3           |       |
| L   | 19.80       | 20.32 | 0.780       | 0.800 |
| L1  | 4.10        | 4.47  | 0.161       | 0.176 |
| øP  | 3.50        | 3.70  | 0.138       | 0.146 |
| Q   | 5.49        | 6.00  | 0.216       | 0.236 |
| S   | 6.04        | 6.30  | 0.238       | 0.248 |

DOCUMENT NO.  
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SCALE  
0 5 7.5mm

EUROPEAN PROJECTION

ISSUE DATE  
09-07-2010

REVISION  
05

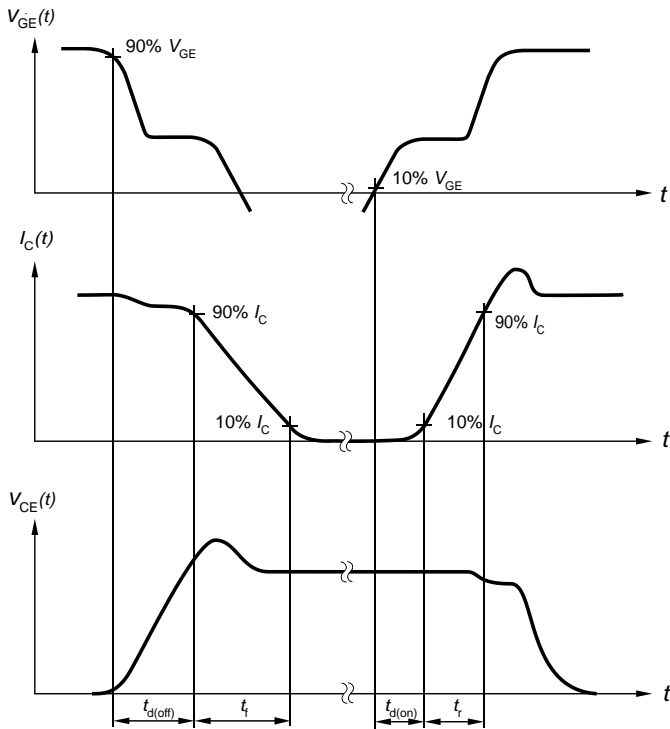


Figure A. Definition of switching times

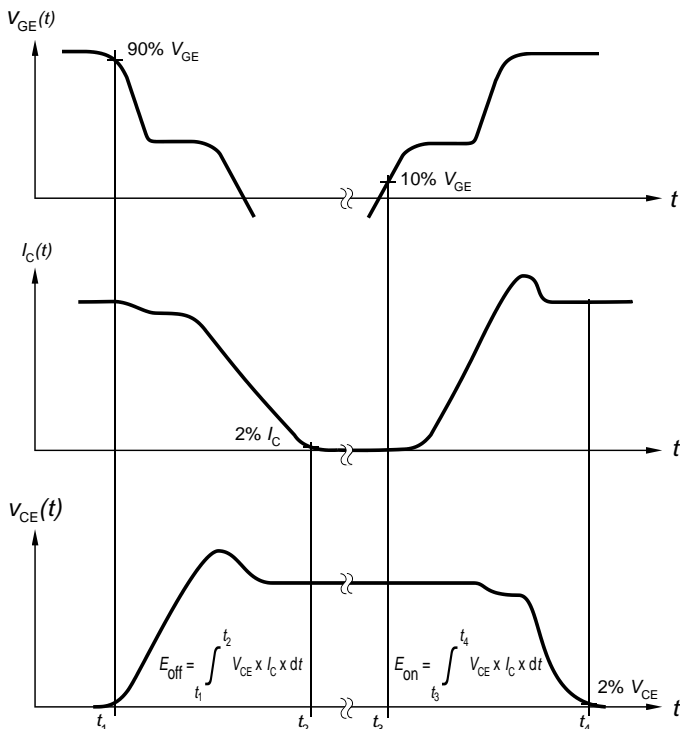


Figure B. Definition of switching losses

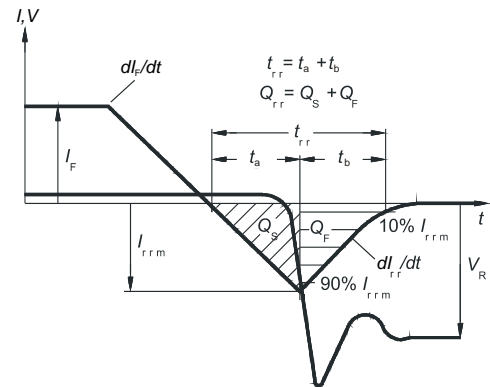


Figure C. Definition of diode switching characteristics

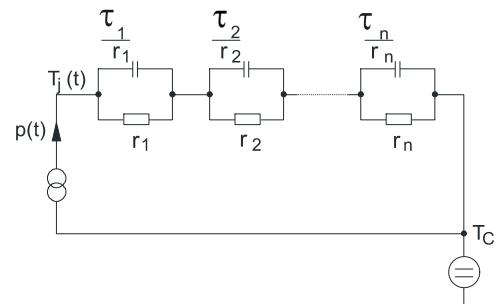


Figure D. Thermal equivalent circuit

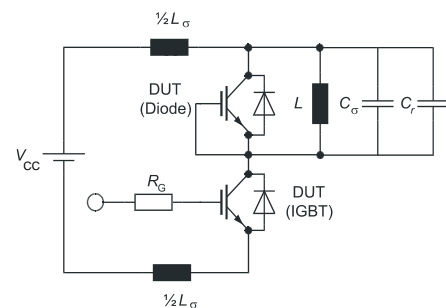


Figure E. Dynamic test circuit  
Parasitic inductance  $L_\sigma$ ,  
parasitic capacitor  $L_\sigma$ ,  
relief capacitor  $C_r$ ,  
(only for ZVT switching)

## Revision History

IGW15N120H3

Revision: 2014-12-01, Rev. 2.1

## Previous Revision

| Revision | Date       | Subjects (major changes since last revision) |
|----------|------------|--|
| 1.1      | 2009-11-27 | -  |
| 2.1      | 2014-12-01 | Final data sheet                             |

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